

Preliminary datasheet

EasyDUAL module with CoolSiC™ Trench MOSFET and PressFIT / NTC

Features

- Electrical features
 - $V_{DSS} = 1200\text{ V}$
 - $I_{DN} = 200\text{ A} / I_{DRM} = 400\text{ A}$
 - Low switching losses
 - Low inductive design
 - High current density
- Mechanical features
 - Rugged mounting due to integrated mounting clamps
 - PressFIT contact technology
 - Integrated NTC temperature sensor



Typical appearance

Potential applications

- Solar applications
- High-frequency switching application
- DC/DC converter
- UPS systems

Product validation

- Qualified for industrial applications according to the relevant tests of IEC 60747, 60749 and 60068

Description

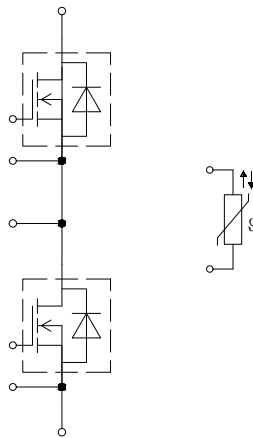


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1 Package

Table 1 Insulation coordination

Parameter	Symbol	Note or test condition	Values	Unit
Isolation test voltage	V_{ISOL}	RMS, $f = 50$ Hz, $t = 1$ min	3.0	kV
Internal isolation		basic insulation (class 1, IEC 61140)	Al_2O_3	
Comparative tracking index	CTI		> 200	
Relative thermal index (electrical)	RTI	housing	140	°C

Table 2 Characteristic values

Parameter	Symbol	Note or test condition	Values			Unit
			Min.	Typ.	Max.	
Stray inductance module	L_{sCE}			8		nH
Module lead resistance, terminals - chip	$R_{CC'+EE'}$	$T_H = 25$ °C, per switch		1.4		mΩ
Storage temperature	T_{stg}		-40		125	°C
Mounting force per clamp	F		40		80	N
Weight	G			39		g

Note: The current under continuous operation is limited to 25 A rms per connector pin.

2 MOSFET

Table 3 Maximum rated values

Parameter	Symbol	Note or test condition	Values	Unit
Drain-source voltage	V_{DSS}	$T_{vj} = 25$ °C	1200	V
Implemented drain current	I_{DN}		200	A
Continuous DC drain current	I_{DDC}	$T_{vj} = 175$ °C, $V_{GS} = 18$ V $T_H = 65$ °C	170	A
Repetitive peak drain current	I_{DRM}	verified by design, t_p limited by T_{vjmax}	400	A
Gate-source voltage, max. transient voltage	V_{GS}	$D < 0.01$	-10/23	V
Gate-source voltage, max. static voltage	V_{GS}		-7/20	V

Table 4 Recommended values

Parameter	Symbol	Note or test condition	Values	Unit
On-state gate voltage	$V_{GS(on)}$		15...18	V

(table continues...)

Table 4 (continued) Recommended values

Parameter	Symbol	Note or test condition	Values	Unit
Off-state gate voltage	$V_{GS(off)}$		-5...0	V

Table 5 Characteristic values

Parameter	Symbol	Note or test condition	Values			Unit	
			Min.	Typ.	Max.		
Drain-source on-resistance	$R_{DS(on)}$	$I_D = 200\text{ A}$	$V_{GS} = 18\text{ V}$, $T_{vj} = 25\text{ °C}$		4		mΩ
			$V_{GS} = 18\text{ V}$, $T_{vj} = 125\text{ °C}$		6.5		
			$V_{GS} = 18\text{ V}$, $T_{vj} = 175\text{ °C}$		8.7		
			$V_{GS} = 15\text{ V}$, $T_{vj} = 25\text{ °C}$		4.9		
Gate threshold voltage	$V_{GS(th)}$	$I_D = 80\text{ mA}$, $V_{DS} = V_{GS}$, $T_{vj} = 25\text{ °C}$, (tested after 1ms pulse at $V_{GS} = +20\text{ V}$)	3.45	4.3	5.15	V	
Total gate charge	Q_G	$V_{DD} = 800\text{ V}$, $V_{GS} = -3/18\text{ V}$		0.594		μC	
Internal gate resistor	R_{Gint}	$T_{vj} = 25\text{ °C}$		1		Ω	
Input capacitance	C_{ISS}	$f = 100\text{ kHz}$, $V_{DS} = 800\text{ V}$, $V_{GS} = 0\text{ V}$	$T_{vj} = 25\text{ °C}$	17.6		nF	
Output capacitance	C_{OSS}	$f = 100\text{ kHz}$, $V_{DS} = 800\text{ V}$, $V_{GS} = 0\text{ V}$	$T_{vj} = 25\text{ °C}$	0.84		nF	
Reverse transfer capacitance	C_{rSS}	$f = 100\text{ kHz}$, $V_{DS} = 800\text{ V}$, $V_{GS} = 0\text{ V}$	$T_{vj} = 25\text{ °C}$	0.056		nF	
C_{OSS} stored energy	E_{OSS}	$V_{DS} = 800\text{ V}$, $V_{GS} = -3/18\text{ V}$, $T_{vj} = 25\text{ °C}$		344		μJ	
Drain-source leakage current	I_{DSS}	$V_{DS} = 1200\text{ V}$, $V_{GS} = -3\text{ V}$	$T_{vj} = 25\text{ °C}$	0.12	660	μA	
Gate-source leakage current	I_{GSS}	$V_{DS} = 0\text{ V}$, $T_{vj} = 25\text{ °C}$	$V_{GS} = 20\text{ V}$		400	nA	
Turn-on delay time (inductive load)	$t_{d\ on}$	$I_D = 200\text{ A}$, $R_{Gon} = 2.7\text{ Ω}$, $V_{DD} = 600\text{ V}$, $V_{GS} = -3/18\text{ V}$	$T_{vj} = 25\text{ °C}$	45		ns	
			$T_{vj} = 125\text{ °C}$	42			
			$T_{vj} = 175\text{ °C}$	42			
Rise time (inductive load)	t_r	$I_D = 200\text{ A}$, $R_{Gon} = 2.7\text{ Ω}$, $V_{DD} = 600\text{ V}$, $V_{GS} = -3/18\text{ V}$	$T_{vj} = 25\text{ °C}$	44		ns	
			$T_{vj} = 125\text{ °C}$	41			
			$T_{vj} = 175\text{ °C}$	41			
Turn-off delay time (inductive load)	$t_{d\ off}$	$I_D = 200\text{ A}$, $R_{Goff} = 1\text{ Ω}$, $V_{DD} = 600\text{ V}$, $V_{GS} = -3/18\text{ V}$	$T_{vj} = 25\text{ °C}$	74		ns	
			$T_{vj} = 125\text{ °C}$	82			
			$T_{vj} = 175\text{ °C}$	86			

(table continues...)

Table 5 (continued) Characteristic values

Parameter	Symbol	Note or test condition	Values			Unit
			Min.	Typ.	Max.	
Fall time (inductive load)	t_f	$I_D = 200\text{ A}$, $R_{Goff} = 1\ \Omega$, $V_{DD} = 600\text{ V}$, $V_{GS} = -3/18\text{ V}$	$T_{vj} = 25\text{ }^\circ\text{C}$		16	ns
			$T_{vj} = 125\text{ }^\circ\text{C}$		16	
			$T_{vj} = 175\text{ }^\circ\text{C}$		16	
Turn-on energy loss per pulse	E_{on}	$I_D = 200\text{ A}$, $V_{DD} = 600\text{ V}$, $L_\sigma = 7\text{ nH}$, $V_{GS} = -3/18\text{ V}$, $R_{Gon} = 2.7\ \Omega$, $di/dt = 8.8\text{ kA}/\mu\text{s}$ ($T_{vj} = 175\text{ }^\circ\text{C}$)	$T_{vj} = 25\text{ }^\circ\text{C}$		3.22	mJ
			$T_{vj} = 125\text{ }^\circ\text{C}$		3.77	
			$T_{vj} = 175\text{ }^\circ\text{C}$		4.29	
Turn-off energy loss per pulse	E_{off}	$I_D = 200\text{ A}$, $V_{DD} = 600\text{ V}$, $L_\sigma = 7\text{ nH}$, $V_{GS} = -3/18\text{ V}$, $R_{Goff} = 1\ \Omega$, $dv/dt = 30\text{ kV}/\mu\text{s}$ ($T_{vj} = 175\text{ }^\circ\text{C}$)	$T_{vj} = 25\text{ }^\circ\text{C}$		0.84	mJ
			$T_{vj} = 125\text{ }^\circ\text{C}$		0.85	
			$T_{vj} = 175\text{ }^\circ\text{C}$		0.86	
SC data	I_{SC}	$V_{GS} = -5/15\text{ V}$, $V_{DD} = 800\text{ V}$, $V_{DSmax} = V_{DSS} - L_{sDS} * di/dt$, $R_G = 10\ \Omega$	$t_p = 2\ \mu\text{s}$, $T_{vj} = 25\text{ }^\circ\text{C}$		1680	A
			$t_p = 2\ \mu\text{s}$, $T_{vj} = 150\text{ }^\circ\text{C}$		1640	
Thermal resistance, junction to heat sink	R_{thJH}	per MOSFET, $\lambda_{grease} = 1\text{ W}/(\text{m}\cdot\text{K})$			0.328	K/W
Temperature under switching conditions	$T_{vj\ op}$		-40		175	$^\circ\text{C}$

Note: The selection of positive and negative gate-source voltages impacts losses and the long-term behavior of the MOSFET and body diode. The design guidelines described in Application Notes AN 2018-09 and AN 2021-13 must be considered to ensure sound operation of the device over the planned lifetime.

$T_{vj,op} > 150\text{ }^\circ\text{C}$ is allowed for operation at overload conditions for MOSFET and body diode. For detailed specifications, please refer to AN 2021-13.

3 Body diode (MOSFET)

Table 6 Maximum rated values

Parameter	Symbol	Note or test condition	Values	Unit
DC body diode forward current	I_{SD}	$T_{vj} = 175\text{ }^\circ\text{C}$, $V_{GS} = -3\text{ V}$ $T_H = 65\text{ }^\circ\text{C}$	85	A

Table 7 Characteristic values

Parameter	Symbol	Note or test condition	Values			Unit	
			Min.	Typ.	Max.		
Forward voltage	V_{SD}	$I_{SD} = 200 \text{ A}, V_{GS} = -3 \text{ V}$	$T_{vj} = 25 \text{ }^\circ\text{C}$		4.2	5.35	V
			$T_{vj} = 125 \text{ }^\circ\text{C}$		3.9		
			$T_{vj} = 175 \text{ }^\circ\text{C}$		3.8		

4 NTC-Thermistor

Table 8 Characteristic values

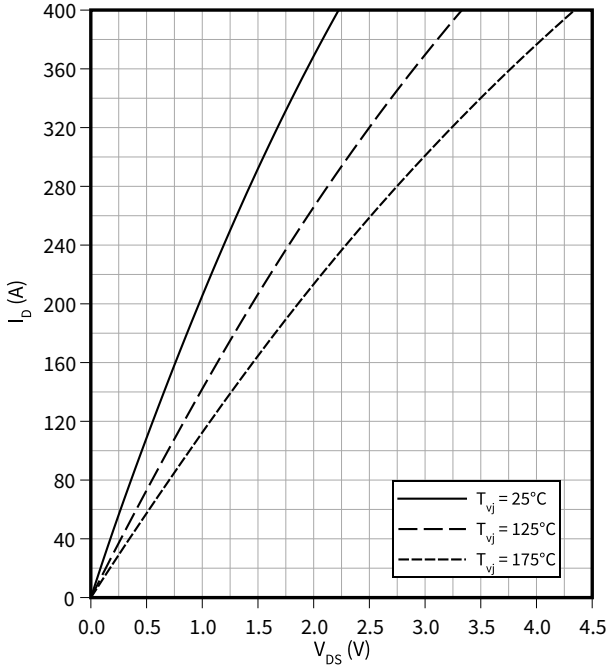
Parameter	Symbol	Note or test condition	Values			Unit
			Min.	Typ.	Max.	
Rated resistance	R_{25}	$T_{NTC} = 25 \text{ }^\circ\text{C}$		5		k Ω
Deviation of R_{100}	$\Delta R/R$	$T_{NTC} = 100 \text{ }^\circ\text{C}, R_{100} = 493 \text{ } \Omega$	-5		5	%
Power dissipation	P_{25}	$T_{NTC} = 25 \text{ }^\circ\text{C}$			20	mW
B-value	$B_{25/50}$	$R_2 = R_{25} \exp[B_{25/50}(1/T_2 - 1/(298,15 \text{ K}))]$		3375		K
B-value	$B_{25/80}$	$R_2 = R_{25} \exp[B_{25/80}(1/T_2 - 1/(298,15 \text{ K}))]$		3411		K
B-value	$B_{25/100}$	$R_2 = R_{25} \exp[B_{25/100}(1/T_2 - 1/(298,15 \text{ K}))]$		3433		K

Note: Specification according to the valid application note.

5 Characteristics diagrams

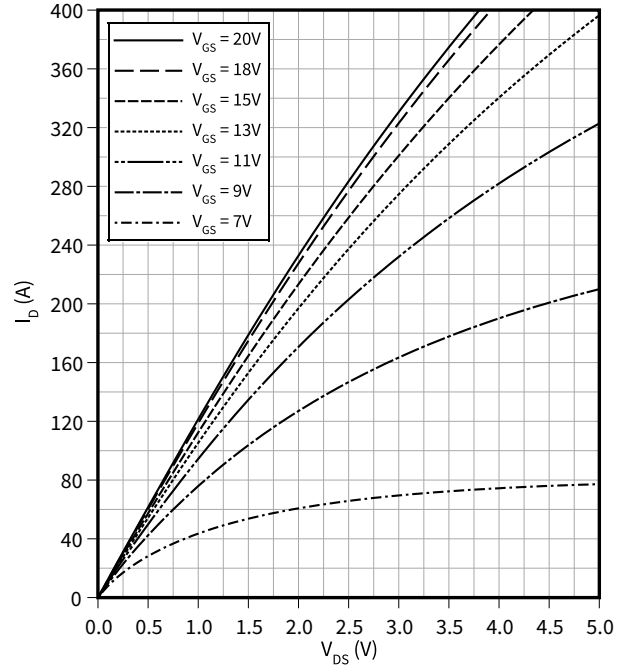
Output characteristic (typical), MOSFET

$I_D = f(V_{DS})$
 $V_{GS} = 15\text{ V}$



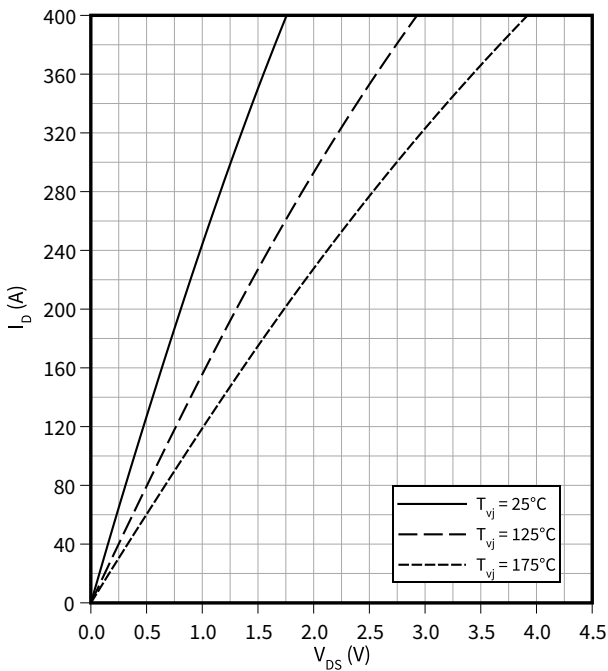
Output characteristic field (typical), MOSFET

$I_D = f(V_{DS})$
 $T_{vj} = 175\text{ °C}$



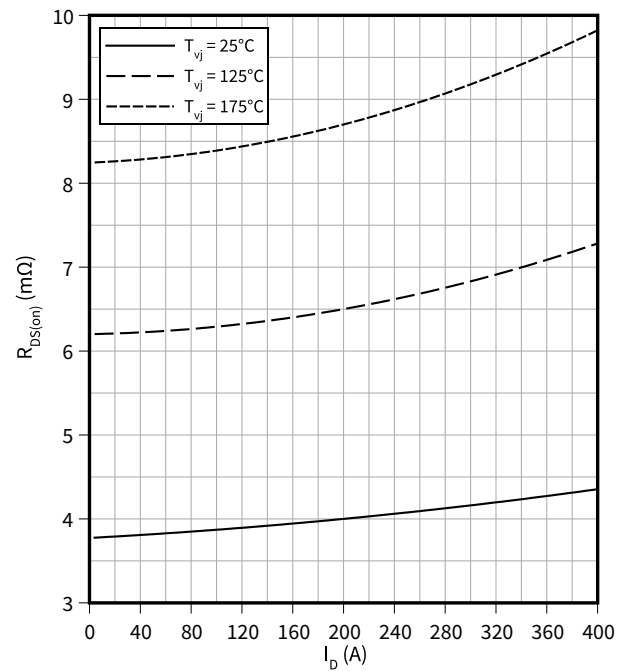
Output characteristic (typical), MOSFET

$I_D = f(V_{DS})$
 $V_{GS} = 18\text{ V}$



Drain source on-resistance (typical), MOSFET

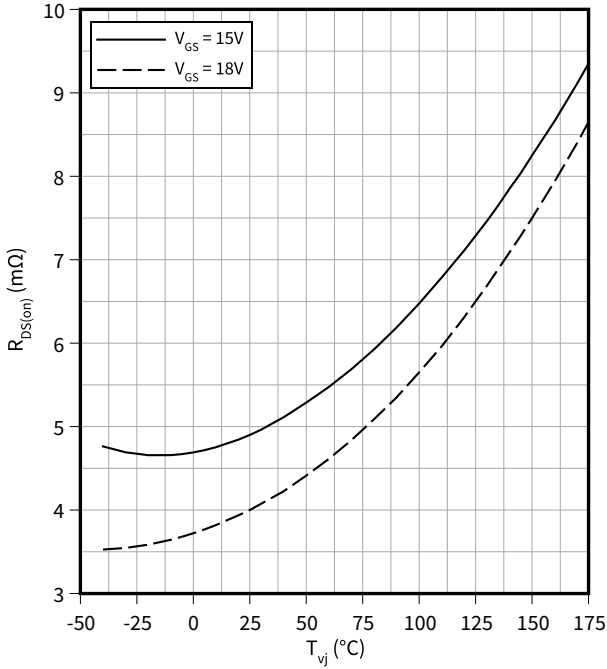
$R_{DS(on)} = f(I_D)$
 $V_{GS} = 18\text{ V}$



5 Characteristics diagrams

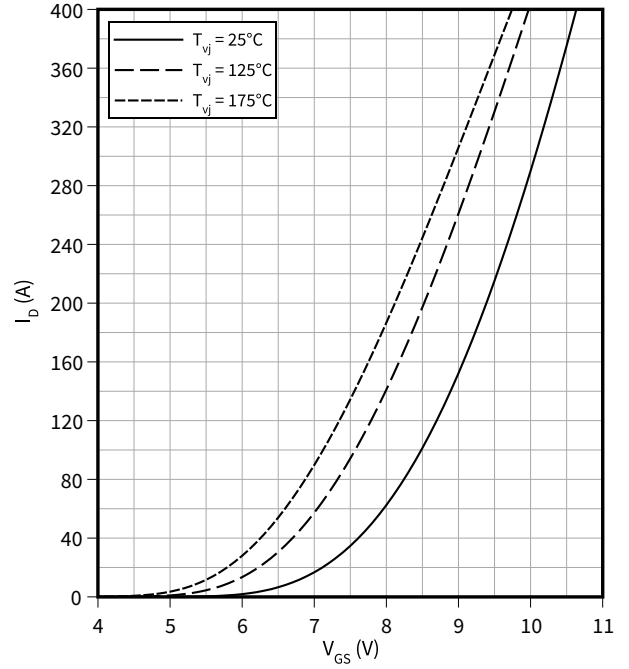
Drain source on-resistance (typical), MOSFET

$R_{DS(on)} = f(T_{vj})$
 $I_D = 200\text{ A}$



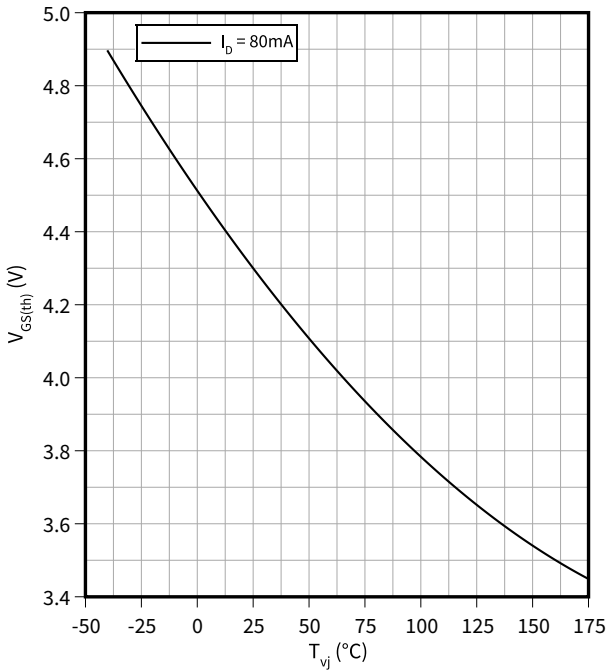
Transfer characteristic (typical), MOSFET

$I_D = f(V_{GS})$
 $V_{DS} = 20\text{ V}$



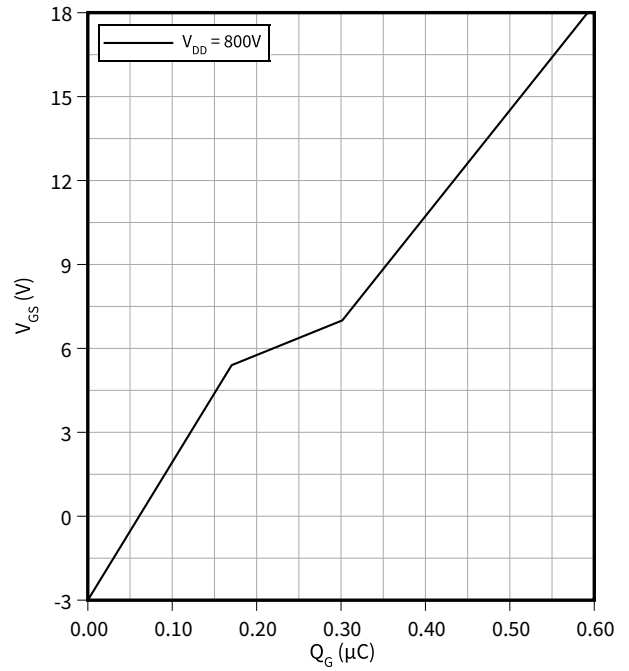
Gate-source threshold voltage (typical), MOSFET

$V_{GS(th)} = f(T_{vj})$
 $V_{GS} = V_{DS}$



Gate charge characteristic (typical), MOSFET

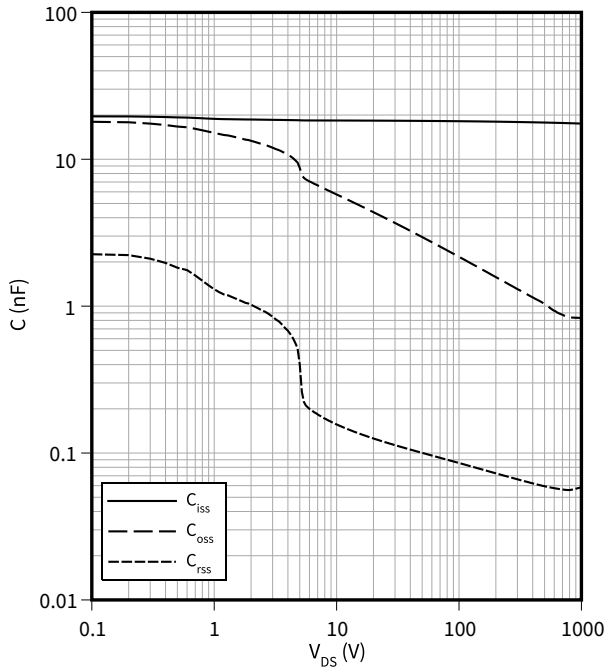
$V_{GS} = f(Q_G)$
 $I_D = 200\text{ A}, T_{vj} = 25^{\circ}C$



5 Characteristics diagrams

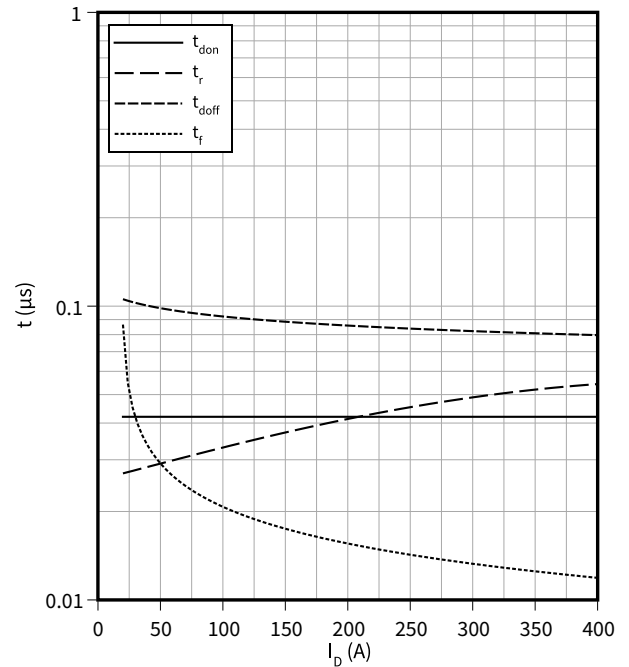
Capacity characteristic (typical), MOSFET

$C = f(V_{DS})$
 $f = 100 \text{ kHz}, T_{vj} = 25 \text{ }^\circ\text{C}, V_{GS} = 0 \text{ V}$



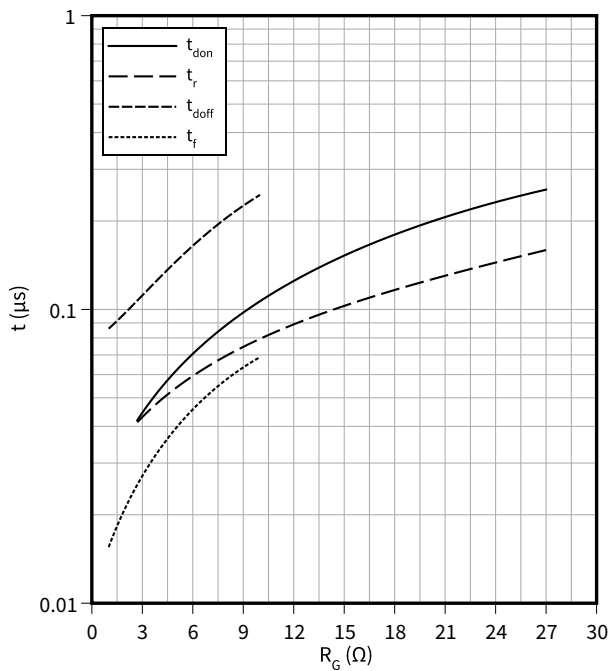
Switching times (typical), MOSFET

$t = f(I_D)$
 $R_{Goff} = 1 \text{ } \Omega, R_{Gon} = 2.7 \text{ } \Omega, V_{DD} = 600 \text{ V}, T_{vj} = 175 \text{ }^\circ\text{C}, V_{GS} = -3/18 \text{ V}$



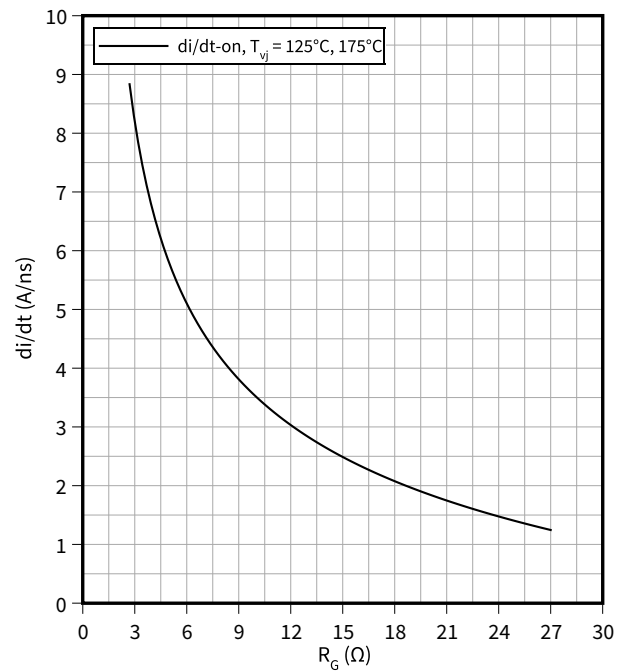
Switching times (typical), MOSFET

$t = f(R_G)$
 $V_{DD} = 600 \text{ V}, I_D = 200 \text{ A}, T_{vj} = 175 \text{ }^\circ\text{C}, V_{GS} = -3/18 \text{ V}$



Current slope (typical), MOSFET

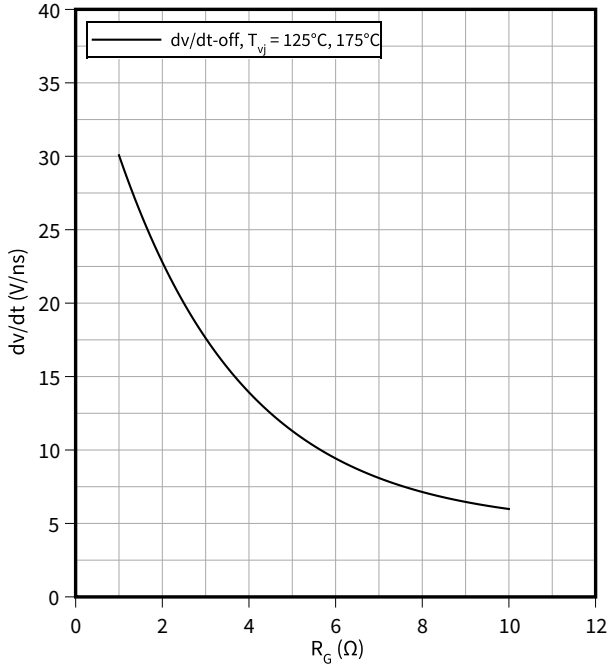
$di/dt = f(R_G)$
 $V_{DD} = 600 \text{ V}, I_D = 200 \text{ A}, V_{GS} = -3/18 \text{ V}$



Voltage slope (typical), MOSFET

$dv/dt = f(R_G)$

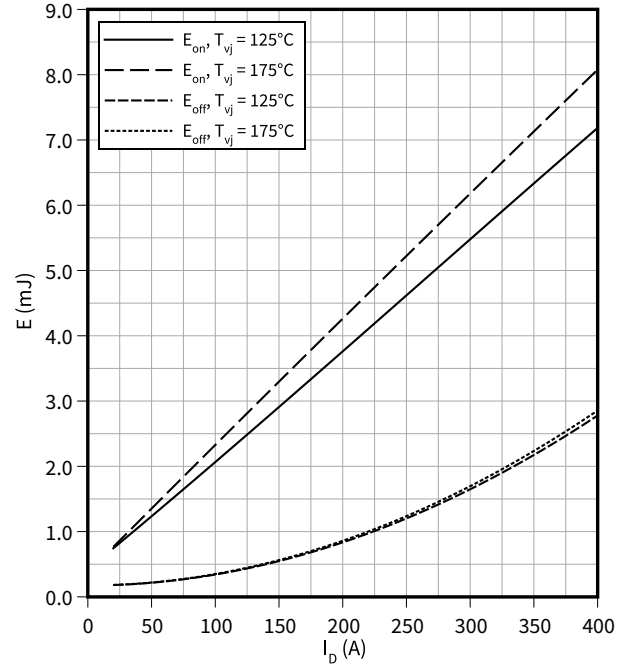
$V_{DD} = 600\text{ V}$, $I_D = 200\text{ A}$, $V_{GS} = -3/18\text{ V}$



Switching losses (typical), MOSFET

$E = f(I_D)$

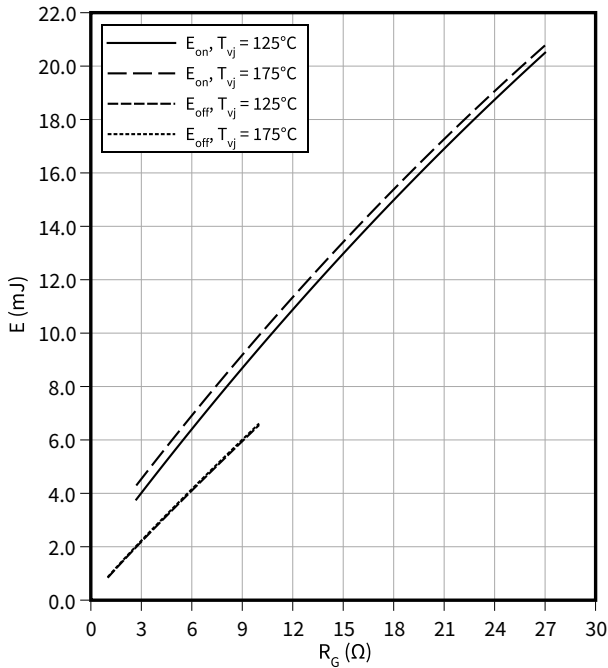
$R_{Goff} = 1\ \Omega$, $R_{Gon} = 2.7\ \Omega$, $V_{DD} = 600\text{ V}$, $V_{GS} = -3/18\text{ V}$



Switching losses (typical), MOSFET

$E = f(R_G)$

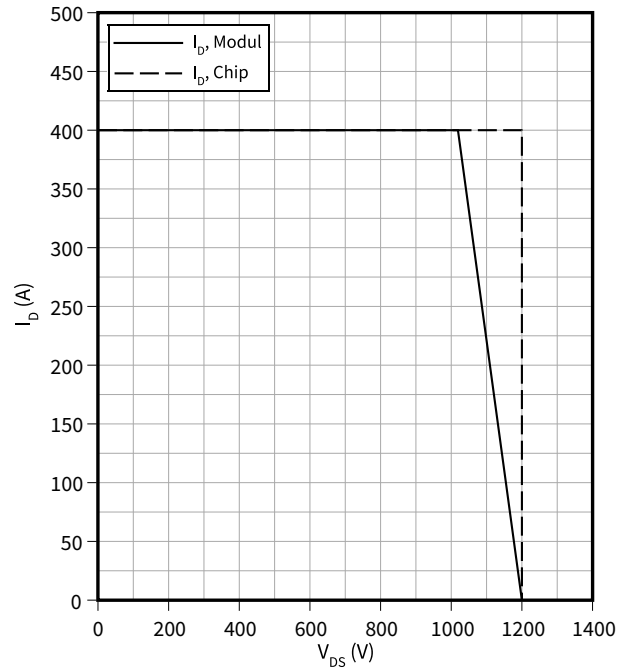
$V_{DD} = 600\text{ V}$, $I_D = 200\text{ A}$, $V_{GS} = -3/18\text{ V}$



Reverse bias safe operating area (RBSOA), MOSFET

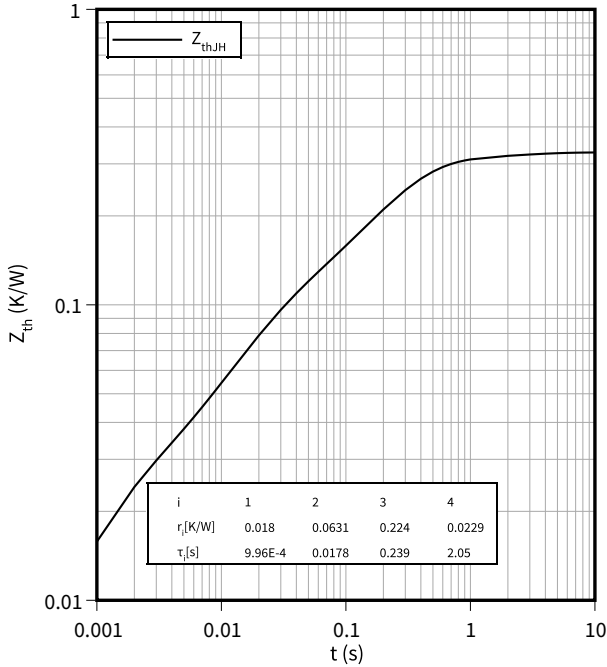
$I_D = f(V_{DS})$

$R_{Goff} = 1\ \Omega$, $T_{vj} = 175\text{ °C}$, $V_{GS} = -3/18\text{ V}$



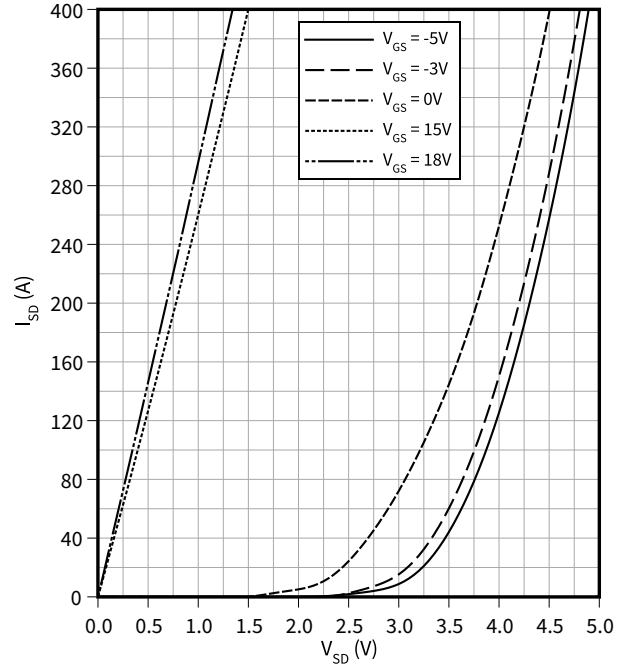
Transient thermal impedance, MOSFET

$Z_{th} = f(t)$



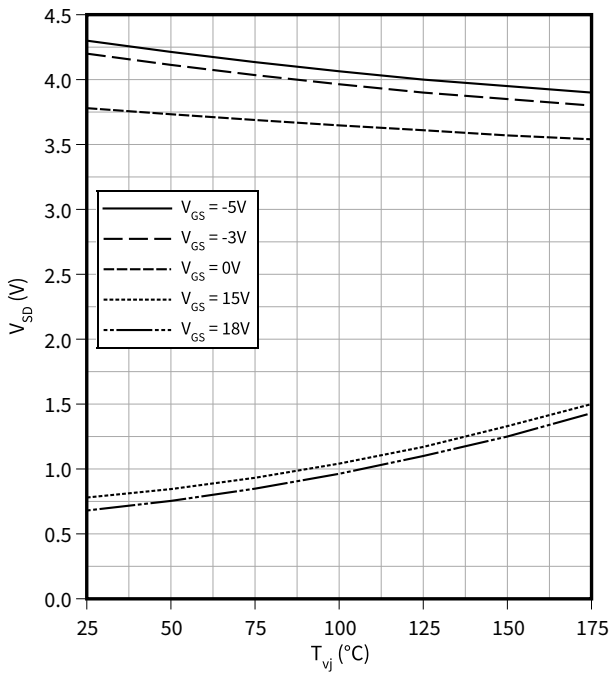
Forward characteristic body diode (typical), MOSFET

$I_{SD} = f(V_{SD})$
 $T_{vj} = 25\text{ }^\circ\text{C}$



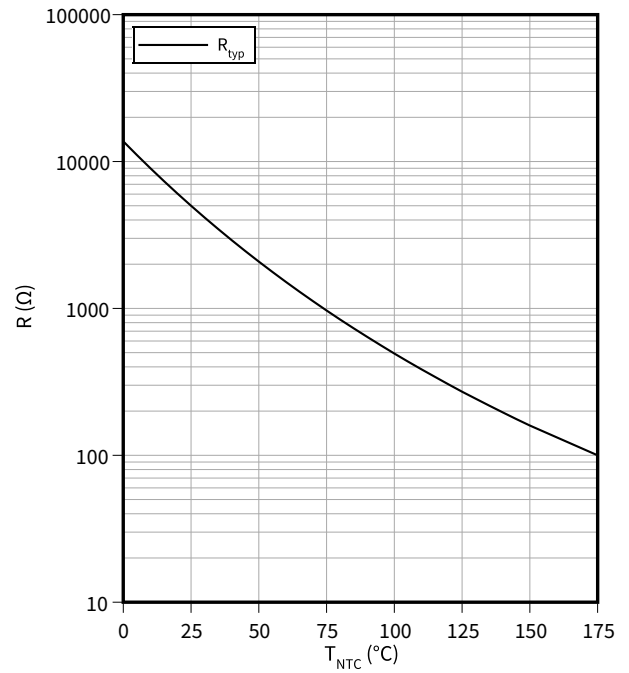
Forward voltage of body diode (typical), MOSFET

$V_{SD} = f(T_{vj})$
 $I_{SD} = 200\text{ A}$



Temperature characteristic (typical), NTC-Thermistor

$R = f(T_{NTC})$



6 Circuit diagram

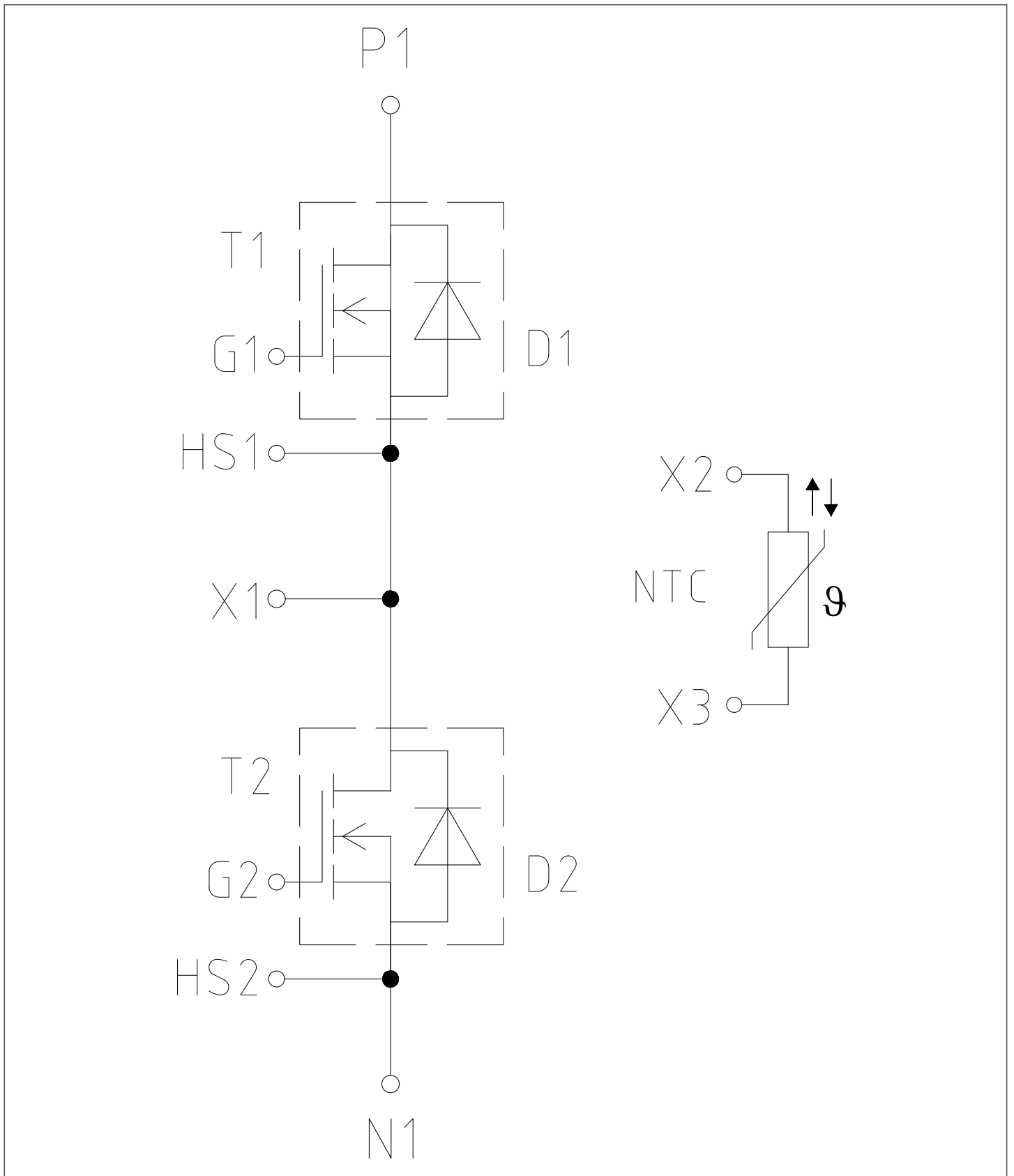


Figure 1

7 Package outlines

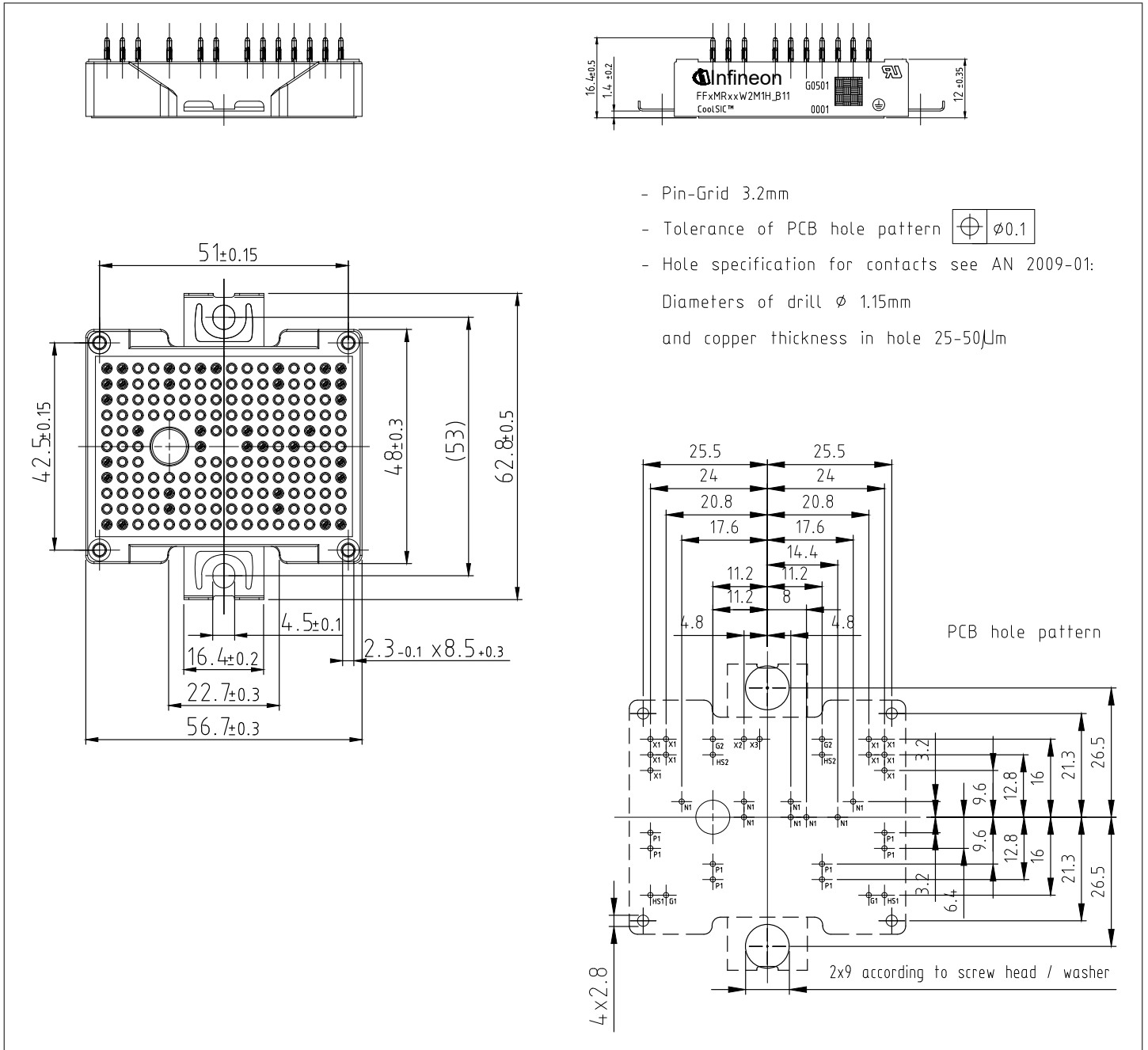


Figure 2

8 Module label code


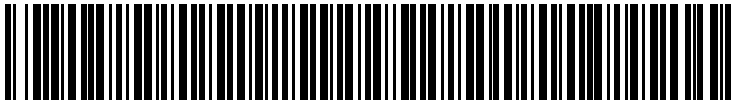
Module label code			
Code format	Data Matrix	Barcode Code128	
Encoding	ASCII text	Code Set A	
Symbol size	16x16	23 digits	
Standard	IEC24720 and IEC16022	IEC8859-1	
Code content	<i>Content</i> Module serial number Module material number Production order number Date code (production year) Date code (production week)	<i>Digit</i> 1 - 5 6 - 11 12 - 19 20 - 21 22 - 23	<i>Example</i> 71549 142846 55054991 15 30
Example	 		<p>71549142846550549911530</p> <p>71549142846550549911530</p>

Figure 3

Revision history

Document version	Date of release	Description of changes
0.10	2022-11-07	Initial version
0.20	2023-05-04	Preliminary datasheet

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[25.320.5253.1](#) [25.334.3253.1](#) [25.334.3353.1](#) [25.350.2053.0](#) [25.352.4753.1](#) [25.522.3253.0](#) [T2180N18TOF](#) [VT](#) [T484C](#) [T485F](#) [T485H](#) [T514F](#)
[T554](#) [25.332.4353.1](#) [25.350.1653.0](#) [25.352.1453.0](#) [25.352.1653.0](#) [25.352.2453.0](#) [25.352.5453.1](#) [25.522.3353.0](#) [25.640.5053.0](#) [M252532V](#)
[M252555](#) [M2550TB400](#) [M505012F-YEC](#) [B512-2T-YDA](#) [TT215N22KOF](#) [TT251N16KOF](#) [V100-35.200N](#) [V50-14.45M](#) [V72-26.150M](#)
[DD700N22K](#) [DD89N16K](#) [DD98N22K](#) [DZ1100N22K](#) [MSD30-12](#) [MSKD120-16](#) [TT425N18KOF](#) [TT500N14KOF](#) [V61-14.80M](#) [EFF18F](#)